

TAS5142DDV6EVM2

This user's guide describes the operation of the evaluation module for the TAS5142 digital amplifier power output stage using the TAS5086 digital audio PWM processor from Texas Instruments. The user's guide also provides measurement data and design information, including schematic, BOM, and PCB layout.

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1 Overview

The TAS5142DDV6EVM2 PurePath Digital™ customer evaluation module demonstrates the integrated circuits TAS5142DDV and TAS5086DBT from Texas Instruments (TI).

The TAS5142DDV is a high-performance, integrated stereo digital amplifier power stage designed to drive 4-Ω speakers at up to 100 W per channel. The device incorporates TI's Equibit™ technology and is designed to be used with TI's Equibit modulators. This system requires only a simple passive demodulation filter to deliver high-quality, high-efficiency audio amplification.

TAS5086DBT is a high-performance 32-bit (24-bit input) multichannel PurePath Digital pulse width modulator (PWM) based on Equibit technology with a new, fully symmetrical AD modulation scheme.

This EVM is configured with 6 BTL channels.

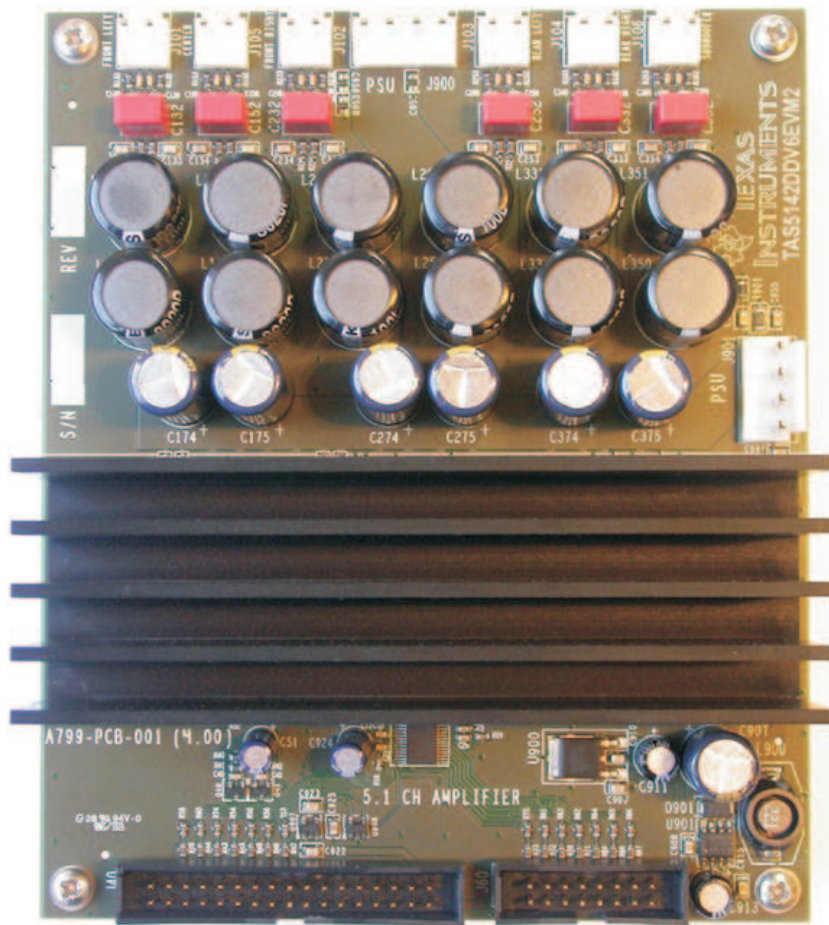
This EVM, together with a TI input-USB board, is a complete 5.1-channel digital audio amplifier system that includes digital input (S/PDIF), analog inputs, interface to PC, and DAP features like digital volume control, input and output multiplexers.

Table 1. TAS5142DDV6EVM2 Specification

| Key Parameters | Values |
|-----------------------------|-----------------------|
| Output stage supply voltage | 0 V–32 V |
| System supply voltage | 15 V–20 V |
| Number of channels | 6 × BTL |
| Load impedance | 4 Ω–8 Ω |
| Output power | 100 W/4 Ω, 10 % THD+N |
| Dynamic range | >105 dB |
| PWM processor | TAS5086DBT |
| Output stage | TAS5142DDV |

This 5.1 system is designed for home theater applications such as A/V receivers, DVD receivers, DVD mini-component systems, or home theater in a box (HTIB).

This document covers EVM specifications, audio performance, power efficiency measurement graphs, and design documentation that includes schematics, parts list, layout, and mechanical design.

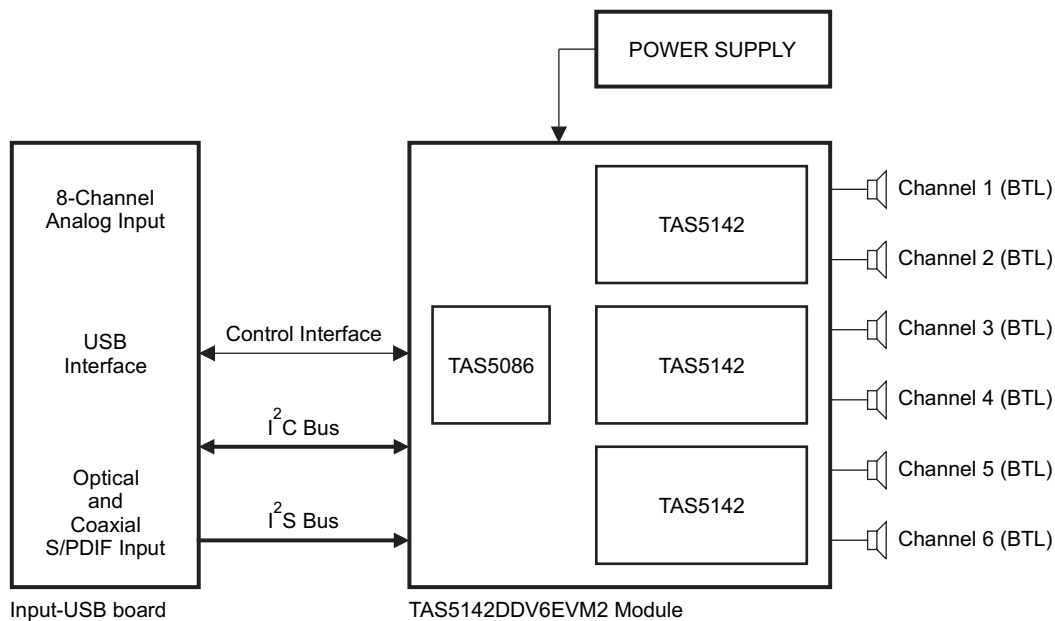


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The EVM is delivered with cables and input-USB board to connect to an input source and be controlled from a PC.

1.1 **TAS5142DDV6EVM2 Features**

- 6-channel PurePath Digital evaluation module
- Self-contained protection system (short-circuit and thermal)
- Standard I²S and I²C/control connector for TI input board
- Double-sided plated-through PCB layout

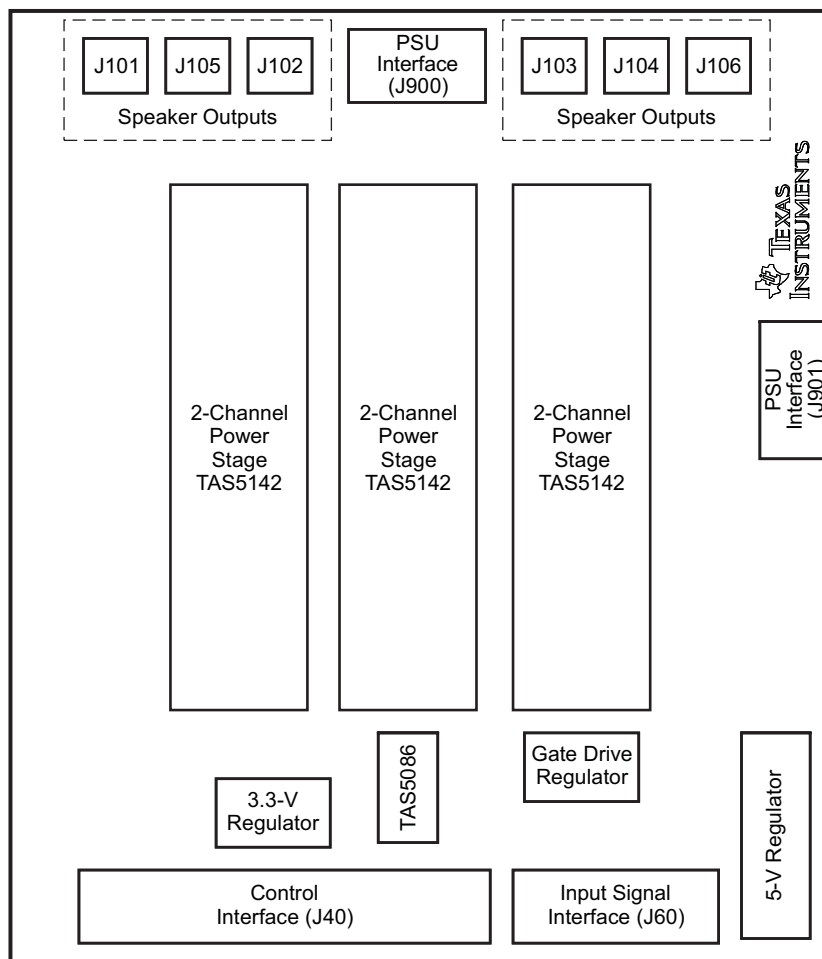


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Figure 1. Integrated PurePath Digital Amplifier System

1.2 PCB Key Map

Physical structure for the TAS5142DDV6EVM2 is illustrated in [Figure 2](#).



M0078-01

Figure 2. Physical Structure for the TAS5142DDV6EVM2 (Approximate Layout)

2 Quick Setup Guide

This chapter describes the TAS5142DDV6EVM2 board regarding power supplies and system interfaces. The chapter provides information on handling and unpacking, absolute operating conditions, and a description of the factory default switch and jumper configuration.

This chapter provides a step-by-step guide to configuring the TAS5142DDV6EVM2 for device evaluation.

2.1 Electrostatic Discharge Warning

Many of the components on the TAS5142DDV6EVM2 are susceptible to damage by electrostatic discharge (ESD). Customers are advised to observe proper ESD handling precautions when unpacking and handling the EVM, including the use of a grounded wrist strap at an approved ESD workstation.

CAUTION

Failure to observe ESD handling procedures may result in damage to EVM components.

2.2 Unpacking the EVM

On opening the TAS5142DDV6EVM2 package, check to ensure that the following items are included:

- 1 pc. TAS5142DDV6EVM2 board using one TAS5086DBT and three TAS5142DDVs
- 1 pc. TI input-USB board for interfacing TAS5142DDV6EVM2 with SPDIF/analog sources and PC for control
- 1 pc. signal interface IDC cable for connection to an I²S front end, such as the attached TI input-USB board
- 1 pc. control interface IDC cable for connection to an I²C front end, such as the attached TI input-USB board
- 1 pc. cable for connecting input-USB board to a USB port on a PC for TAS5086 control by software
- 1 pc. power-supply cable for two regulated power supplies (H-bridge and system supply)
- 1 pc. PurePath CD-ROM

If any of these items is missing, contact the Texas Instruments Product Information Center nearest you to inquire about a replacement.

Connect the input-USB board to the TAS5142DDV6EVM2 using the two IDC cables provided.

2.3 Power-Supply Setup

To power up the EVM, two power supplies are needed, one for system power, logic, and gate-drive, and one for the output-stage supply. Power supplies are connected to the EVM using the provided power cable red/black, white/black.

Table 2. Recommended Supply Voltages

| Description | Voltage Limitations | Current Requirement | Cable |
|---------------------------|---------------------|---------------------|-------------|
| System power supply | 15 V–20 V | 0.3 A | Red/black |
| Output-stage power supply | 0 V–32 V | 10 A | White/black |

CAUTION

Applying voltages above the limitations given in [Table 2](#) may cause permanent damage to your hardware.

Note: The length of the power-supply cable must be minimized. Increasing the length of the PSU cable increases the distortion for the amplifier at high output levels and low frequencies.

2.4 Speaker Connection

CAUTION

Both positive and negative speaker outputs are floating and may not be connected to ground (e.g., through an oscilloscope).

2.5 GUI Software Installation

The TAS5086 GUI provides easy control of all registers in TAS5086. To install the GUI, run the setup file from the PurePath CD-ROM.

After installation, turn on the power supplies and connect the USB cable to the input-USB board.

Start the GUI program from the Windows™ menu. Start-up of the GUI takes a few seconds.



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Figure 3. TAS5086 GUI Window

Quick Setup Guide

From the files menu, load the configuration file:

TAS5142DDV6EVM2 Configuration (2.00).cfg

The file is located on the PurePath CD-ROM. This file contains all settings for a default setup of the EVM.

For easy access of the file, it is recommended to copy the file into the directory where the GUI is installed. Default is C:\Program Files\Texas Instruments Inc\TAS5086\.

For more advanced use of the GUI, see the GUI User's Guide on the PurePath CD-ROM and the *TAS5086 PurePath Digital Audio Six-Channel PWM Processor* data sheet ([SLES131](#)).

3 Protection

This chapter describes the short-circuit protection and fault reporting circuitry of the TAS5142 device.

3.1 Short-Circuit Protection and Fault Reporting Circuitry

The TAS5142 is a self-protecting device that provides fault reporting (including high-temperature protection and short-circuit protection). The TAS5142 is configured in back-end auto-recovery mode and therefore resets automatically after all errors (M1 and M3 are set low, M2 is set high); see the *TAS5142 Stereo Digital Amplifier Power Stage* data sheet ([SLES126](#)) for further explanation. This means that the device will protect itself after an error condition and report the error through the \overline{SD} error signal.

3.2 Fault Reporting

The \overline{OTW} and \overline{SD} outputs from the TAS5142 indicate fault conditions. See the *TAS5142 Stereo Digital Amplifier Power Stage* data sheet ([SLES126](#)) for a description of these pins.

Table 3. TAS5142 Warning/Error Signal Decoding

| \overline{OTW} | \overline{SD} | Device Condition |
|------------------|-----------------|--|
| 0 | 0 | High-temperature error and/or high-current error |
| 0 | 1 | High-temperature warning |
| 1 | 0 | Undervoltage lockout or high-current error |
| 1 | 1 | Normal operation, no errors/warnings |

The temperature warning signals at the TAS5142DDV6EVM2 board are wired-OR to one temperature warning signal (\overline{OTW} – pin 22 in control interface connector). Shutdown signals are wired-OR into one shutdown signal (\overline{SD} – pin 20 in control interface connector).

The shutdown signals, together with the temperature warning signal, give chip state information as described in [Table 3](#). Device fault-reporting outputs are open-drain outputs.

4 TAS5142DDV6EVM Performance

Table 4. General Test Conditions

| General Test Conditions | | Notes |
|-----------------------------|--------------------|--|
| Output stage supply voltage | 32 V | Laboratory power supply (EA-PS 7065-10A) |
| System supply voltage | 15 V | |
| Load Impedance | 4 Ω | |
| Input signal | 1-kHz sine | |
| Sampling frequency | 48 kHz | |
| Gain setting in TAS5086 | 0 dB | |
| Measurement filter | AES17 and AUX-0025 | |
| TI input-USB board | Input-USB | Rev 9 S/N:898 |
| EVM configuration file | Ver 2.00 | TAS5142DDV6EVM2 Configuration (2.00).cfg |

Table 5. TAS5086 Register Settings⁽¹⁾

| Register Name | Register Number | Value | Notes |
|--|-----------------|-------------|-------------------------------------|
| Oscillator trim register | 0x1B | 0x00 | Initiate oscillator to factory trim |
| Master volume register | 0x07 | 0x30 | Set volume to 0 dB |
| Modulation limit register | 0x10 | 0x04 | Set maximum modulation to 96.1% |
| Split-capacitor charge period register | 0x1A | 0x00 | No split-capacitor charge period |
| PWM start register | 0x18 | 0x30 | |
| Input mux register | 0x20 | 00 01 23 45 | |
| PWM mux register | 0x25 | 00 01 23 45 | |
| System control register | 0x05 | 0x20 | |

⁽¹⁾ These register settings are used for all tests, unless otherwise specified.

Table 6. Electrical Data

| Electrical Data | | Notes/Conditions |
|------------------------------------|---------|---|
| Output power, 4 Ω | 80 W | 1 kHz, unclipped (0 dBFS), $T_A = 25^\circ\text{C}$ |
| Output power, 4 Ω | 100 W | 1 kHz, 10% THD+N, $T_A = 25^\circ\text{C}$ |
| Maximum peak current | >10 A | 1-kHz burst, 1 Ω , $R_{OC} = 22 \text{ k}\Omega$ |
| Output stage efficiency | 83% | 1 kHz, $2 \times 100 \text{ W}$, 4 Ω |
| Damping factor | 12 | 1 kHz, relative to 8- Ω load |
| System supply current | <200 mA | 1-kHz, -60-dBFS signal, with TI input board |
| H-bridge supply current | <250 mA | 1-kHz, -60-dBFS signal |
| Total board idle power consumption | 11 W | H-bridge supply + system supply, -60-dBFS signal |

Table 7. Audio Performance

| Audio Performance | | | Notes/Conditions |
|---------------------|------|------------|--|
| THD+N, 4 Ω | 1 W | < 0.08% | 1 kHz |
| THD+N, 4 Ω | 10 W | < 0.15% | 1 kHz |
| THD+N, 4 Ω | 80 W | < 0.25% | 1 kHz |
| Dynamic range | | > 105 dB | Ref: rated power, A-weighted, AES17 filter, 6-ch average |
| Noise voltage | | < 85 μVrms | A-weighted, AES17 |
| Click/pop | | < 20 mV | Mute/unmute, no signal, 4 Ω |
| Channel separation | | > 58 dB | 1 kHz |
| Frequency response: | | ±1 dB | 80 W/4 Ω, unclipped (0 dBFS) |

Table 8. Thermal Specification

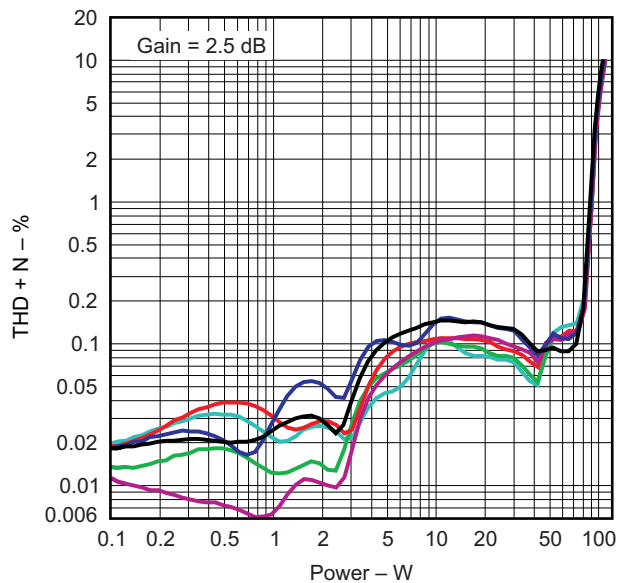
| Thermal Specification | T _{HEATSINK} ⁽¹⁾ | Notes/Conditions |
|---|--------------------------------------|---|
| Idle, all channels switching | 40°C | 1 kHz, 15 min, -60-dBFS signal, T _A = 25°C |
| 4 × 10 W, 4 Ω + 2 × 21 W, 4 Ω (1/8 power) | 68°C | 1 kHz, 1 h, T _A = 25°C |
| 2 × 80 W, 4 Ω | 83°C | 1 kHz, 5 min, T _A = 25°C |

(1) Measured on surface of heat sink

Table 9. Physical Specifications

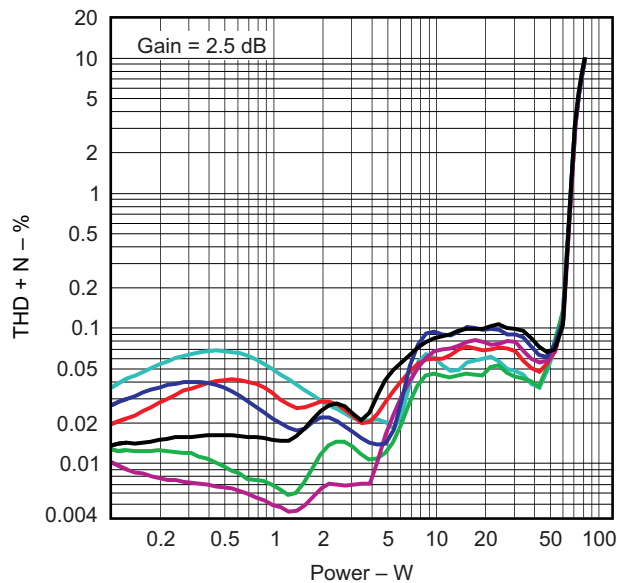
| Physical Specifications | Notes/Conditions |
|-------------------------|---|
| PCB dimensions | 115 × 135 × 50 Width × length × height (mm) |
| Total weight | 330 g Components + PCB + heat sink + mechanics |

Note: All electrical and audio specifications are typical values.



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Figure 4. THD+N vs Power (4 Ω)



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Figure 5. THD+N vs Power (6 Ω)

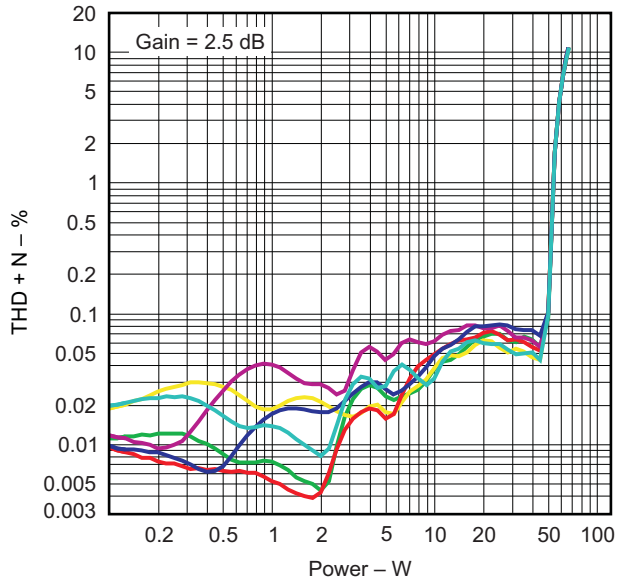


Figure 6. THD+N vs Power (8 Ω)

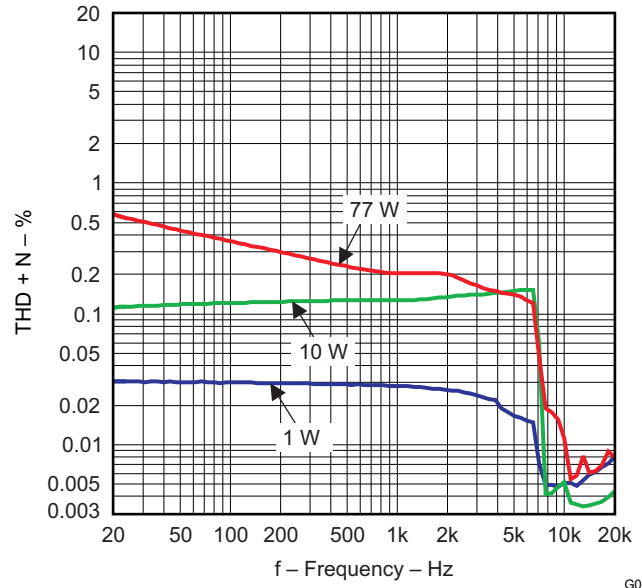


Figure 7. THD+N vs Frequency (4 Ω)

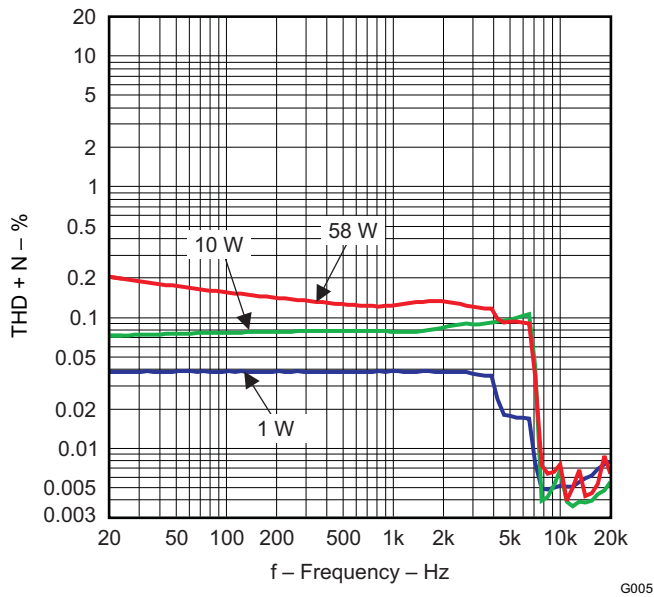


Figure 8. THD+N vs Frequency (6 Ω)

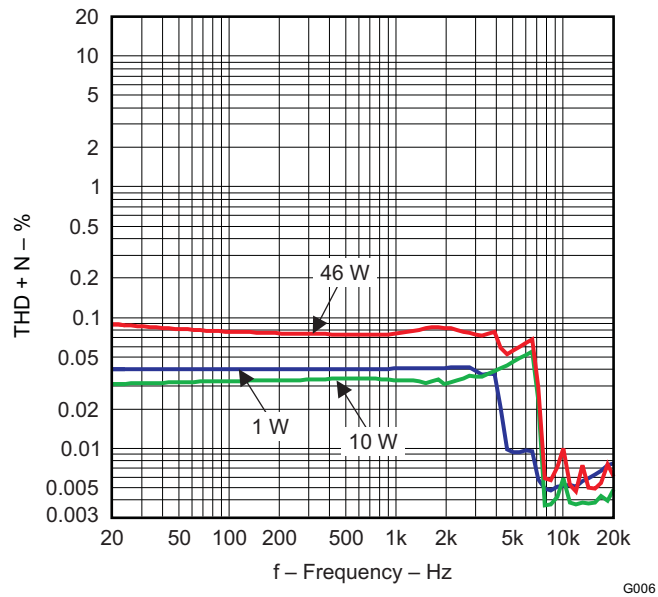


Figure 9. THD+N vs Frequency (8 Ω)

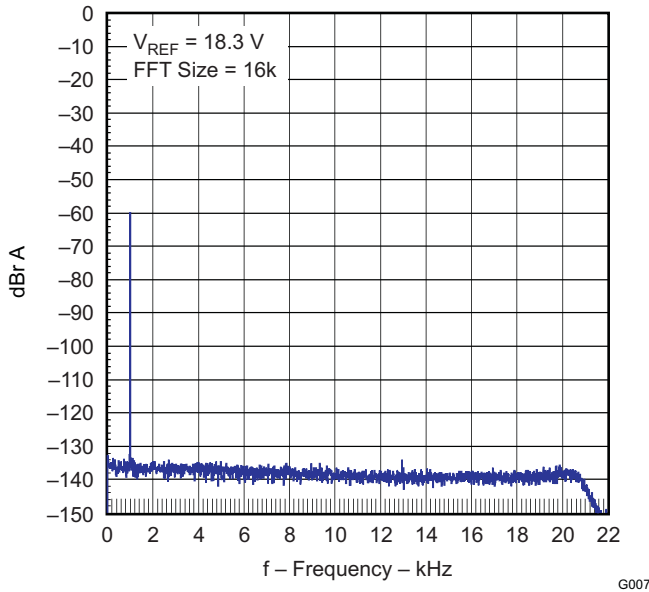


Figure 10. FFT Spectrum With -60 dBFS Tone

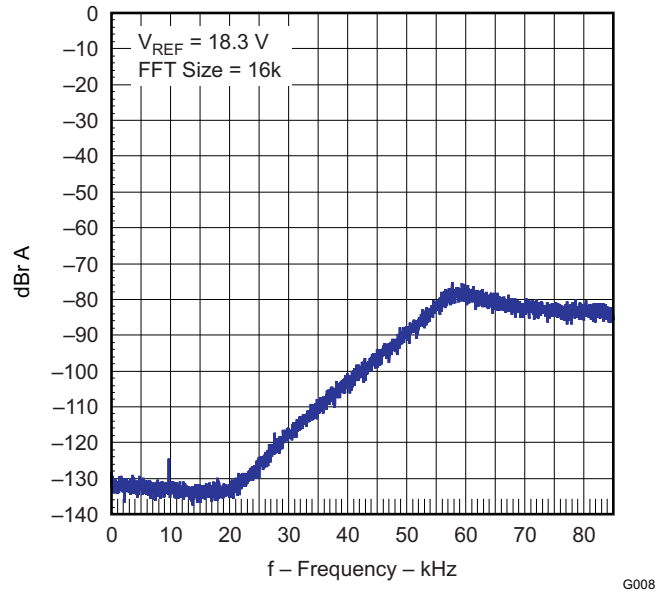


Figure 11. Idle Noise FFT Spectrum

Channel separation is tested for two channels, channel 1 and channel 2. Both channels use 4-Ω loads. The channel 1 input signal is 0 dBFS; channel 2 is muted. Reference voltage is 18.3 Vrms.

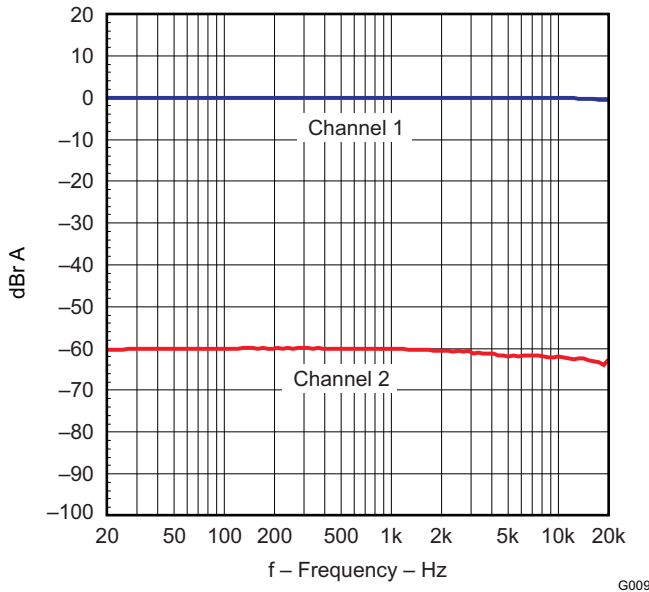


Figure 12. Channel Separation

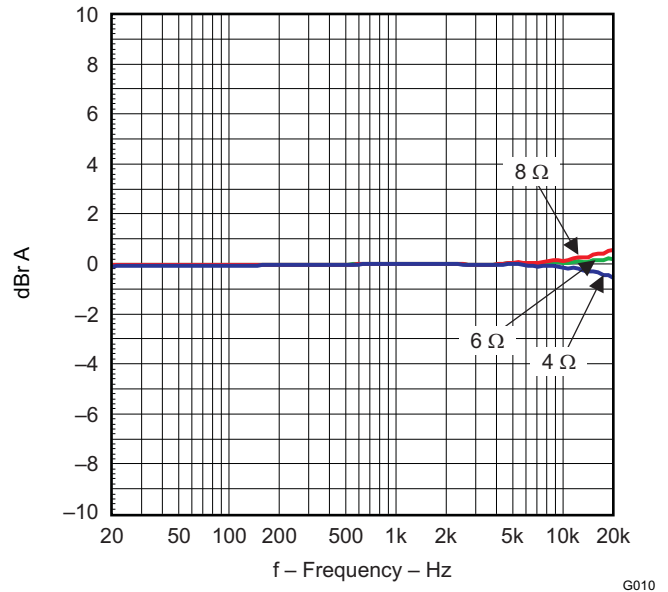


Figure 13. Frequency Response

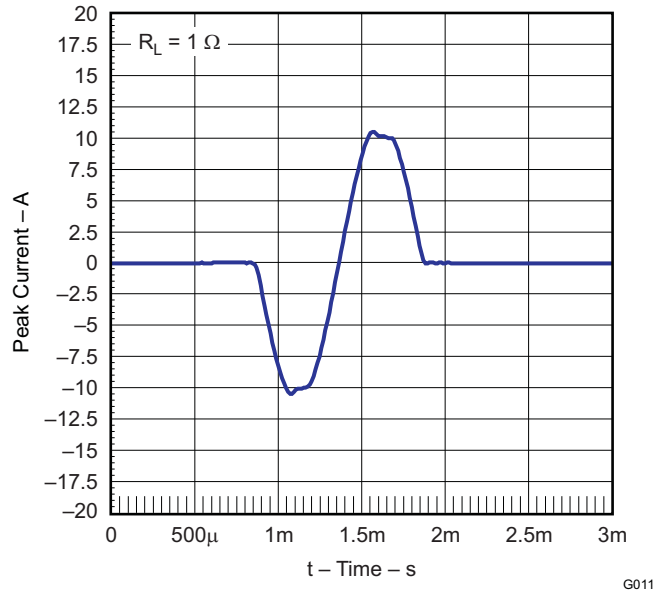


Figure 14. High Current Protection

No input signal is applied. Load is 4Ω .

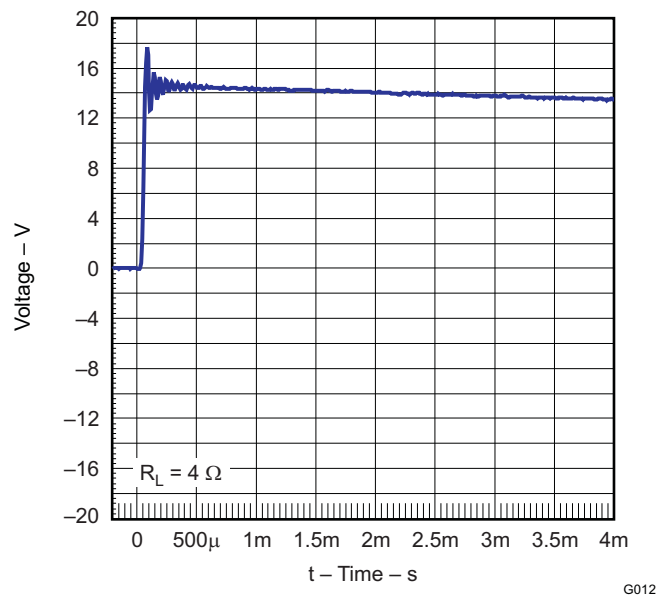


Figure 15. Pop/Click

Efficiency is tested with 2 channels loaded at $4\ \Omega$. The board has been preheated for 1 hour at 1/8 output power.

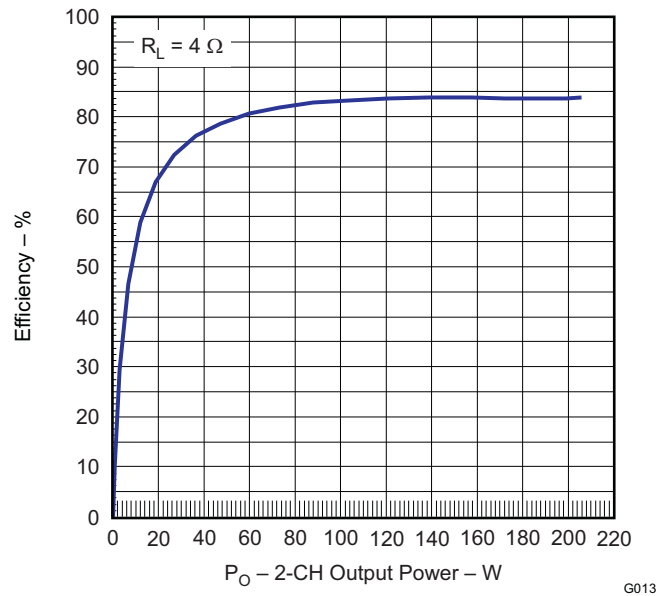


Figure 16. Output Stage Efficiency

5 Related Documentation from Texas Instruments

The following table contains a list of data manuals that have detailed descriptions of the integrated circuits used in the design of the TAS5142DDV6EVM2. The data manuals can be obtained at the URL <http://www.ti.com>.


| Part Number | Literature Number |
|--------------------|--------------------------|
| TAS5086 | SLES131 |
| TAS5142 | SLES126 |
| TPS3825-33 | SLVS165 |
| TPS76433 | SLVS180 |
| UA78M12 | SLVS059 |

5.1 Additional Documentation

1. *PC Configuration Tool for TAS5086* (TAS5086 GUI version 4.0 or later), on the PurePath CD-ROM
2. *System Design Considerations for True Digital Audio Power Amplifiers* ([SLAA117](#))
3. *Digital Audio Measurements* ([SLAA114](#))
4. *PSRR for PurePath Digital Audio Amplifiers* ([SLEA049](#))
5. *Power Rating in Audio Amplifier* ([SLEA047](#))
6. *PurePath Digital AM Interference Avoidance* ([SLEA040](#))
7. *Click and Pop Measurements Technique* ([SLEA044](#))
8. *Power Supply Recommendations for DVD-Receivers* ([SLEA027](#))
9. *Implementation of Power Supply Volume Control* ([SLEA038](#))

Appendix A Design Documents

A.1 TAS5142DDV6EVM2 Schematic



Design Name: TAS5142DDV6EVM2
Type: Mass Market Evaluation Module
File Name: A799-SCH-001.DSN
Version: 5.00
Date: 21.Nov. 2006
Design Engineer: Tomas Bruunshuus (tbs@ti.com), Jonas Holm (jhh@ti.com)
Audio Configuration: 5.1 PurePath Digital Amplifier Design
 1 x TAS5086, 3 x TAS5142DDV

Interfaces:
 J40: 34 pin IDC Header for Control, I2C and +5V
 J60: 16 pin IDC Header for I2S Audio
 J101-J106: 2 pin 3.96mm Headers for Speakers
 J901: 4 pin 3.96mm Header for H-Bridge and System Power Supply

Setup:
 6 x 4 ohm Speaker Loads
 +32V H-Bridge and +15V System Power Supplies

Performance:
 6 x 100W/4ohm (BTL) - all 10% THD+N
 100dB Dynamic Range

Page
 1/7: Front Page and Schematic Disclaimer
 2/7: Overview - Modulator, Input/Output and Headphone/Line Output Connectors
 3/7: 4 Channel BTL Power Stage (FL and C)
 4/7: 2 Channel BTL Power Stage (FR and RL)
 5/7: 2 Channel BTL Power Stage (RR and LFE SW)
 6/7: Power Supplies
 7/7: Mechanics

TEXAS INSTRUMENTS

TAS5142DDV6EVM2
 Mass Market Evaluation Module
 A799-SCH-001.DSN
 5.00
 21.Nov. 2006
 Tomas Bruunshuus (tbs@ti.com), Jonas Holm (jhh@ti.com)
 1 x TAS5086, 3 x TAS5142DDV

Figure A-1. TAS5142DDV6EVM2 Schematic (Sheet 1 of 7)

NOTE

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TAS5142DDV6EVM2 Schematic

S002

TAS5142DDV6EVM2

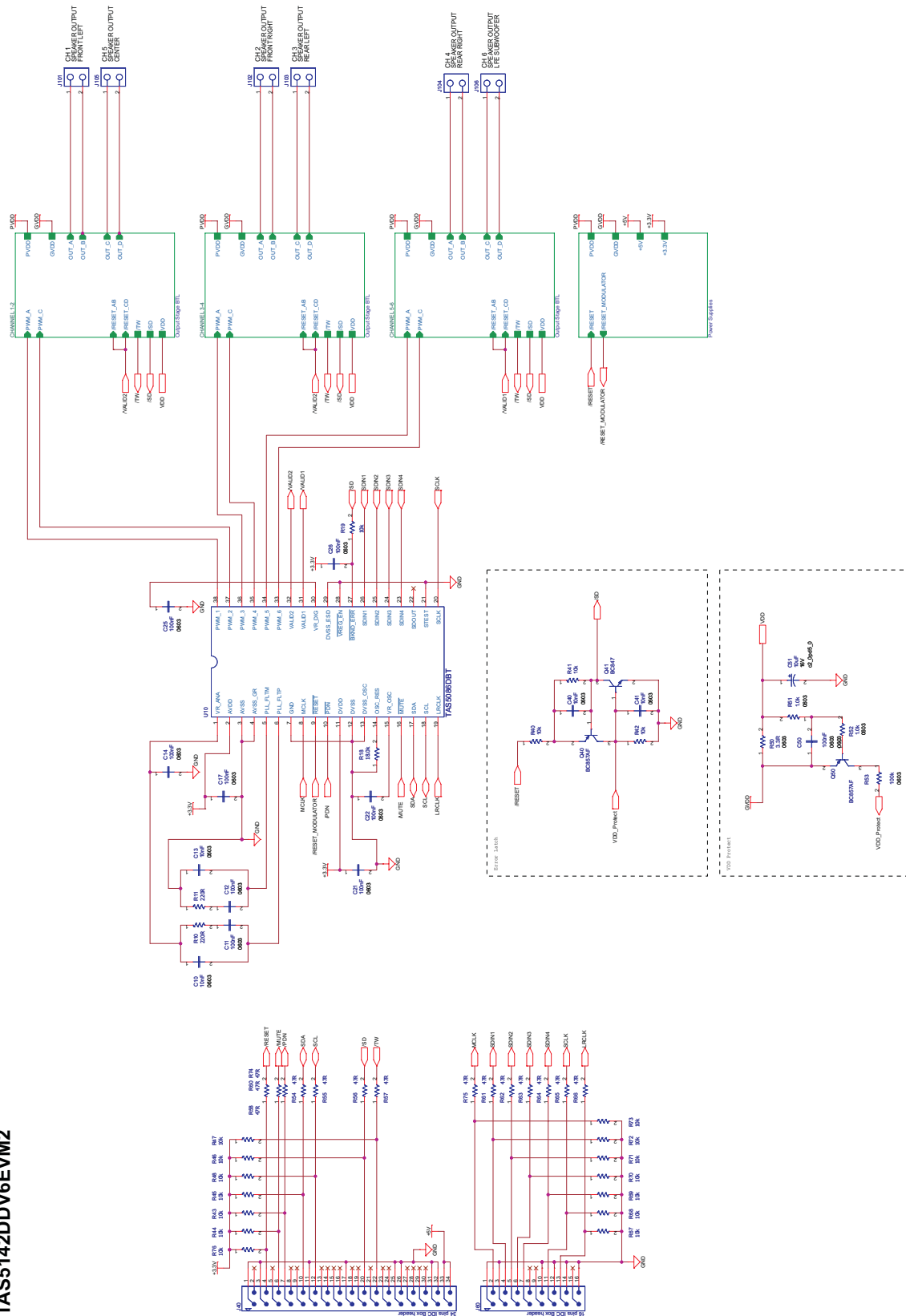
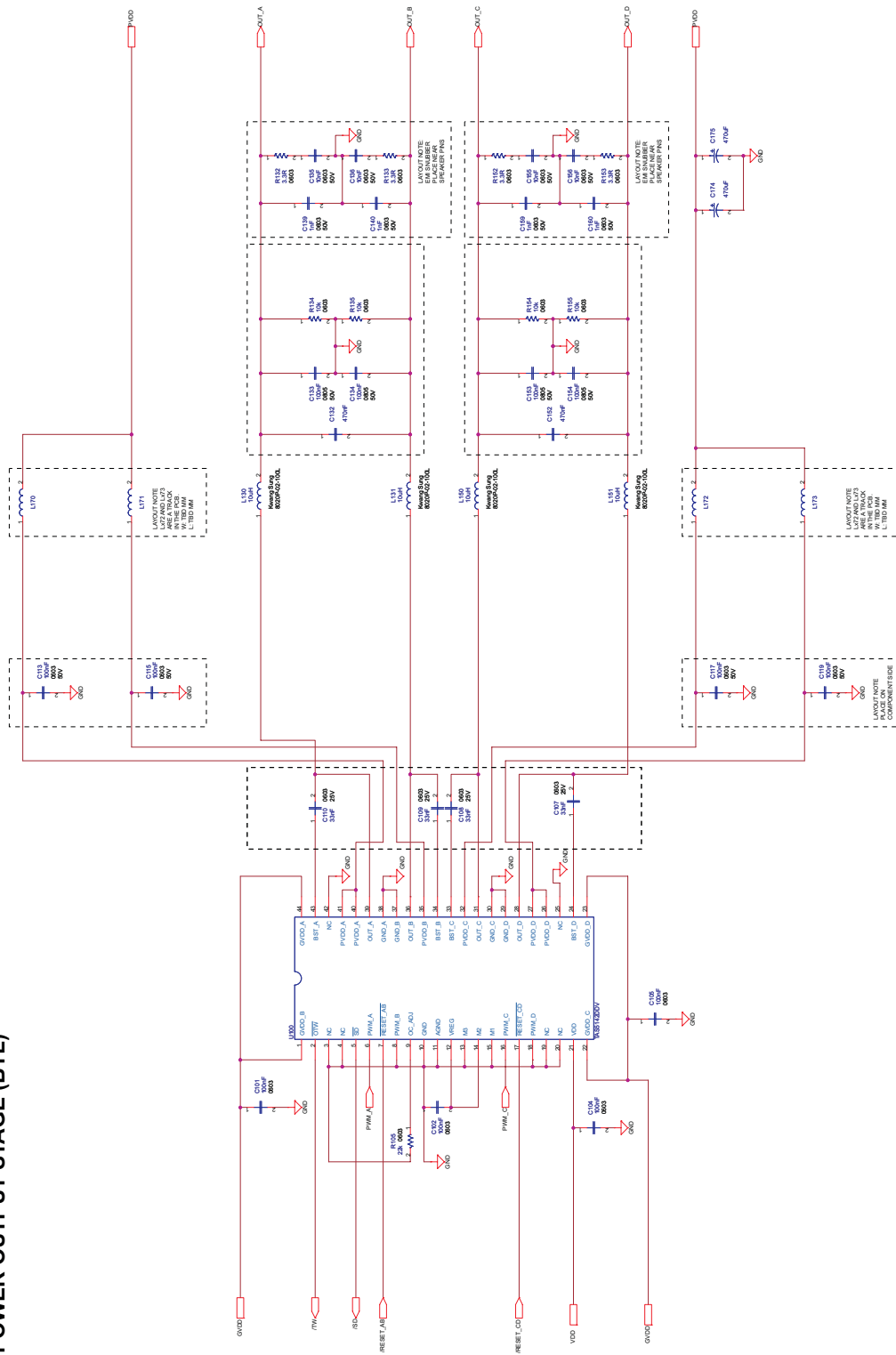


Figure A-2. TAS5142DDV6EVM2 Schematic (Sheet 2 of 7)

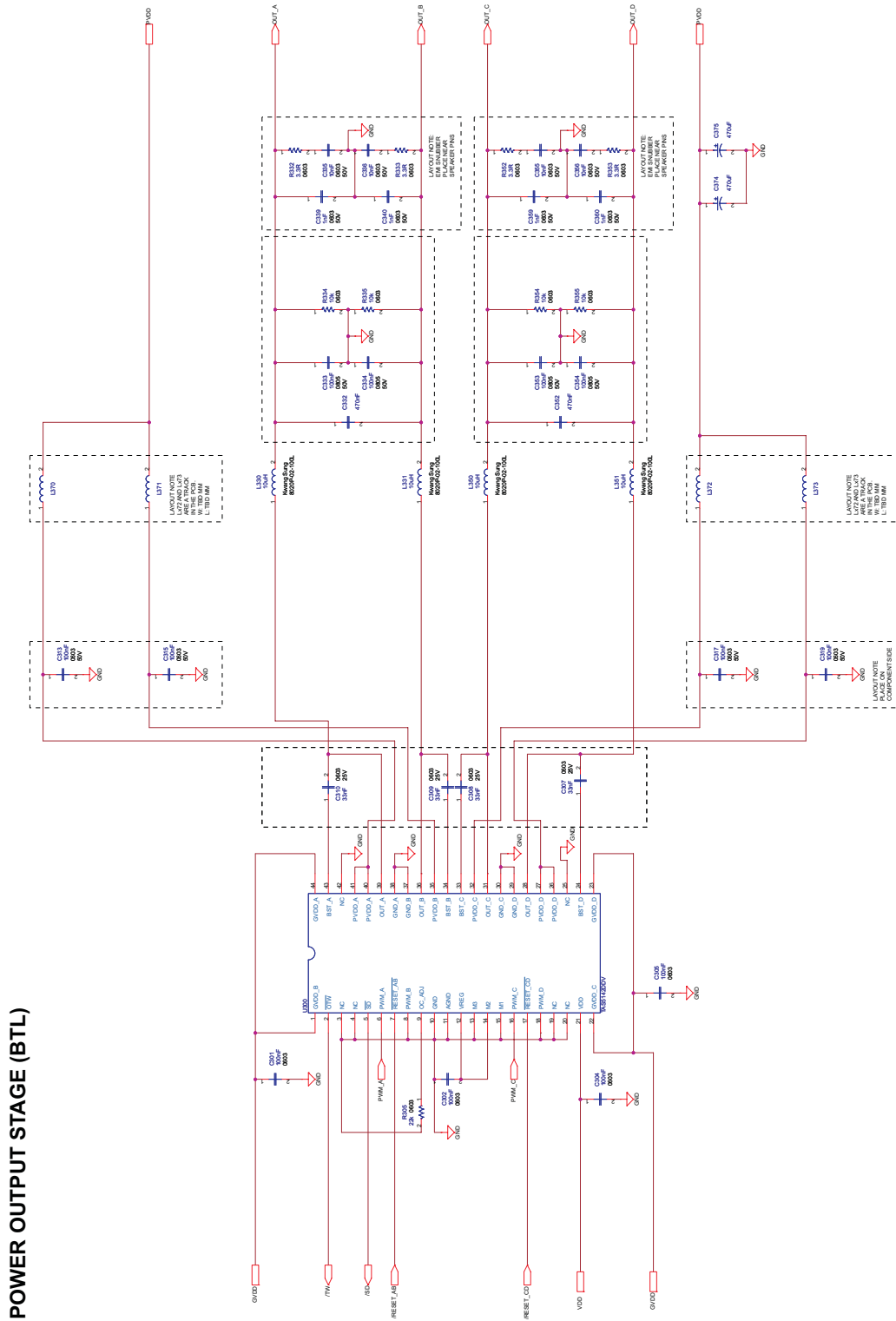
POWER OUTPUT STAGE (BTL)



Mod. Title Description
 M2 011 Type TAS5142DDV6EVM2
 L 1 2007L TAS5142DDV6EVM2 Rev. 2.0
 H 1 2007L TAS5142DDV6EVM2 Rev. 2.0
 H 1 2007L TAS5142DDV6EVM2 Rev. 2.0
 H 1 2007L TAS5142DDV6EVM2 Rev. 2.0

Figure A-3. TAS5142DDV6EVM2 Schematic (Sheet 3 of 7)

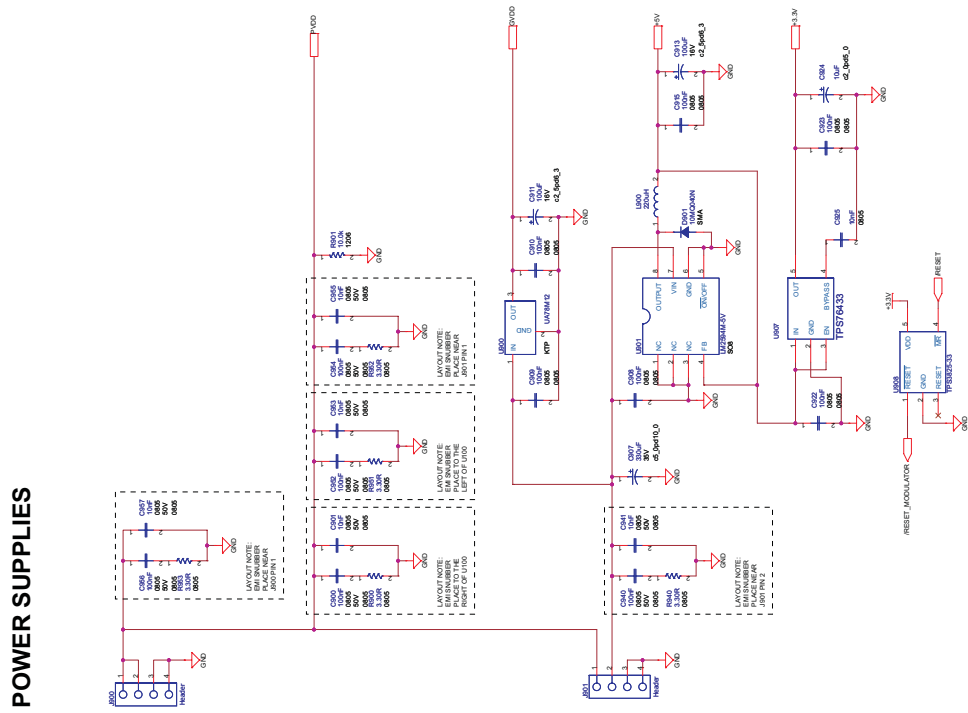
S003



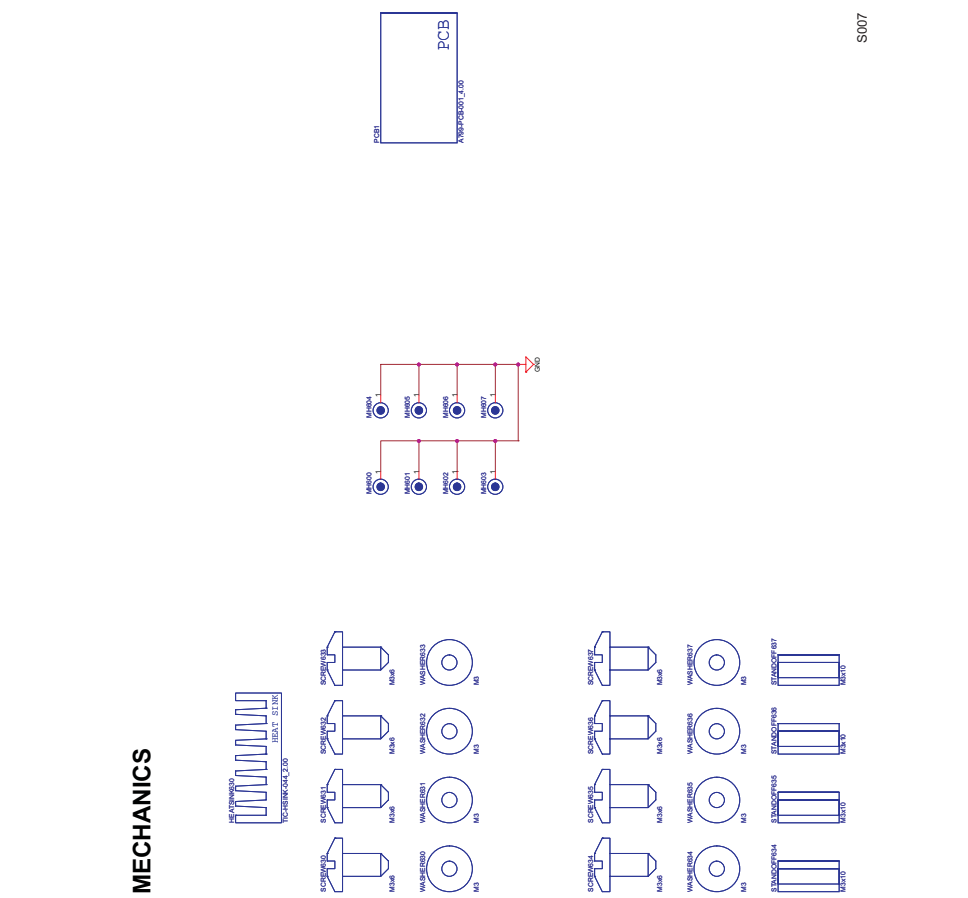
Mod. Title Description
 M2 M1 Type
 L 1 2481L All Information, 24-Pin Low-Power, 20V, 2-Channel BTL
 L 1 2481L All Information, 20V, 2-Channel BTL
 L 1 2481L All Information, 20V, 2-Channel BTL
 L 1 2481L All Information, 20V, 2-Channel BTL

Figure A-5. TAS5142DDV6EVM2 Schematic (Sheet 5 of 7)

S005



S006



S007

A.2 TAS5142DDV6EVM2 Parts List

Table A-1. Parts List

| Part Reference | QTY | Description | Manufacture | First MFR P/N |
|--|-----|---|-------------------------|--------------------------------------|
| C10 C13 C40 C41 C135 C136 C155 C156 C235 C236 C255 C256 C335 C336 C355 C356 | 16 | Ceramic 10-nF, 50-V, 20% X7R 0603 capacitor | BC Components | 0603B103M500NT |
| C11 C12 C14 C17 C21 C22 C25 C26 C50 C101 C102 C104 C105 C201 C202 C204 C205 C301 C302 C304 C305 | 21 | Ceramic 100-nF, 16-V, 20% X7R 0603 capacitor | BC Components | 0603B104M160NT |
| C51 C924 | 2 | Electrolytic 10- μ F, 16-V, 20% aluminium 2-mm \varnothing 5-mm M-series general-purpose capacitor | Panasonic | ECA1CM100 |
| C107 C108 C109 C110 C207 C208 C209 C210 C307 C308 C309 C310 | 12 | Ceramic 33-nF, 25-V, 20% X7R 0603 capacitor | BC Components | 0603B333M250NT |
| C113 C115 C117 C119 C213 C215 C217 C219 C313 C315 C317 C319 | 12 | Ceramic 100-nF, 50-V, 20% X7R 0603 capacitor | Vishay | VJ0603Y104MXATW1BC |
| C132 C152 C232 C252 C332 C352 | 6 | Metal film 470-nF, 63-V, 10% polyester 5-mm (W: 4,5 mm L: 7,2 mm) capacitor | Wima | MKS 2 0.47 μ F/105/63Vdc PCM5 |
| C133 C134 C153 C154 C233 C234 C253 C254 C333 C334 C353 C354 C900 C908 C909 C910 C915 C922 C923 C940 C952 C954 C956 | 23 | Ceramic 100-nF, 50-V, 20% X7R 0805 capacitor | BC Components | 0805B104M500NT |
| C139 C140 C159 C160 C239 C240 C259 C260 C339 C340 C359 C360 | 12 | Ceramic 1-nF, 50-V, 10% NP0 0603 capacitor | BC Components | 0603N102K500NT |
| C174 C175 C274 C275 C374 C375 | 6 | Electrolytic 470- μ F, 35-V, 20% aluminium 5-mm \varnothing 10 mm FC-series low-impedance capacitor | Panasonic | EEUFC1V471 |
| C901 C925 C941 C953 C955 C957 | 6 | Ceramic 10-nF, 50-V, 20% X7R 0805 capacitor | BC Components | 0805B103M500NT |
| C907 | 1 | Electrolytic 330- μ F, 35-V 20% aluminium 5-mm \varnothing 10-mm FC-series low-impedance capacitor | Panasonic | EEUFC1V331 |
| C911 C913 | 2 | Electrolytic 100- μ F, 16-V, 20% aluminium 2,5-mm \varnothing 6,3 mm ultramini-series capacitor | Sang Jing Electronics | UMR16V107M6.3X5 |
| D901 | 1 | 1-A, 40-V Schottky diode (SMA) | International Rectifier | 10MQ040N |
| HEATSINK630 | 1 | Heat sink for 3 DDV packages, length 110 mm | THF-Teknik | TIC-HSINK-044(2.00) |
| J40 | 1 | 34 pins/2 rows/2,54-mm pitch vertical male IDC | Molex | 87256-3411 |
| J60 | 1 | 16 pins/2 rows/2,54-mm pitch vertical male IDC | Molex | 87256-1611 |
| J101 J102 J103 J104 J105 J106 | 6 | 2 pins/1 row/3,96-mm pitch vertical male pin header | JST | BEP-VH |
| J900 J901 | 2 | 4 pins/1 row/3,96-mm pitch vertical male pin header | JST | B4P-VH |
| L130 L131 L150 L151 L230 L231 L250 L251 L330 L331 L350 L351 | 12 | 10- μ H ferrite inductor | Kwang Sung | 8020P-02-100L |
| L900 | 1 | 220 μ H, 0.5-A, 20% (390mR) magnetically shielded ferrite inductor | Coil Craft | DT3316P-224 |
| PCB1 | 1 | TAS5142DDV6EVM2 printed circuit board (version 4.00) - Allegro | Printline | A799-PCB-001(4.00) |
| Q40 Q50 | 2 | 100-mA, 45-V PNP small signal transistor (SOT-23) | Philips | 9335 897 40215 |
| Q41 | 1 | 100-mA, 45-V NPN small-signal transistor (SOT-23) | Philips | 9335 895 70215 |

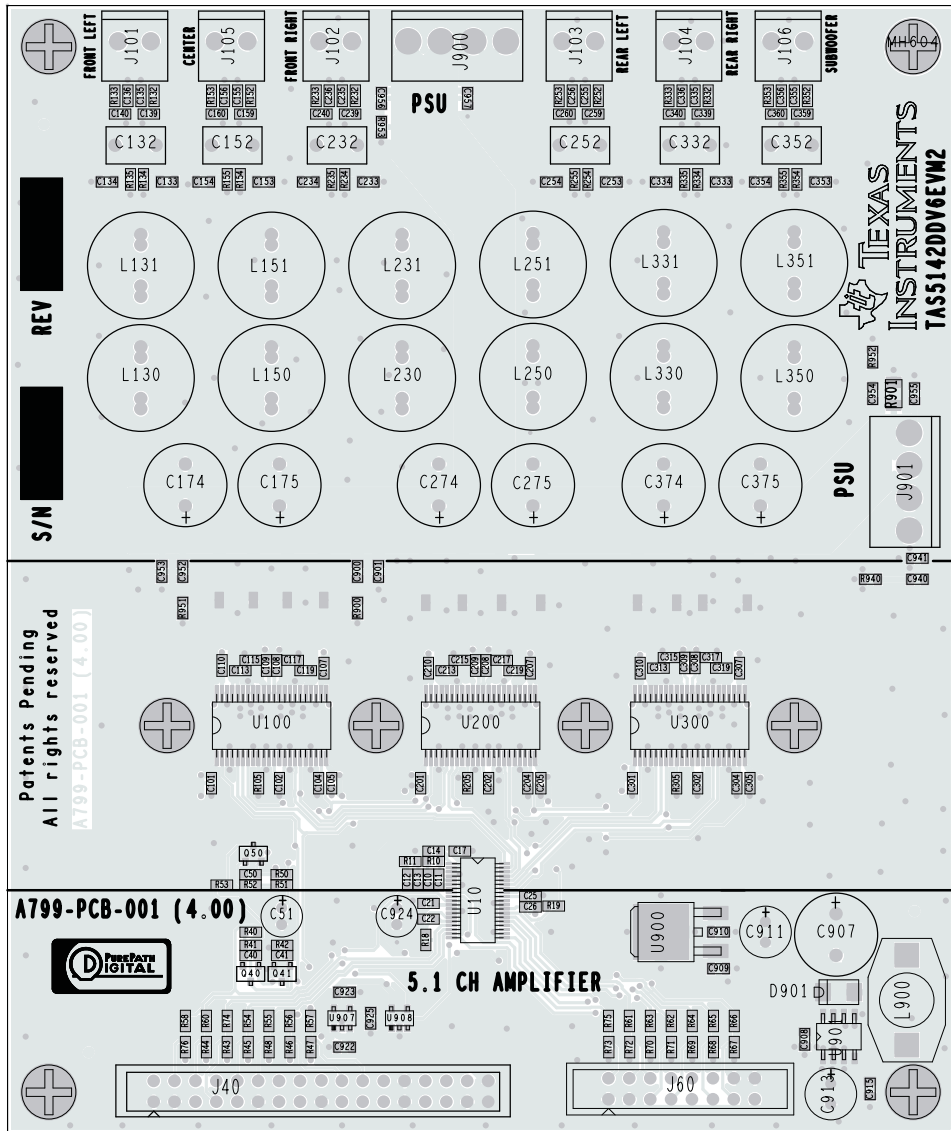
Table A-1. Parts List (continued)

| Part Reference | QTY | Description | Manufacture | First MFR P/N |
|--|-----|---|------------------------|------------------|
| R10 R11 | 2 | 220-Ω, 100-mW 5% 0603 metal film resistor | BC Components | DCT 0603 5% 220R |
| R18 | 1 | 18.0-kΩ, 100-mW, 1% 0603 metal film resistor | BC Components | DCT 0603 1% 18k0 |
| R19 R40 R41 R42 R43 R44 R45 R46 R47 R48 R67 R68 R69 R70 R71 R72 R73 R76 R134 R135 R154 R155 R234 R235 R254 R255 R334 R335 R354 R355 | 30 | 10-kΩ, 100-mW, 5% 0603 metal film resistor | BC Components | DCT 0603 5% 10k0 |
| R50 R132 R133 R152 R153 R232 R233 R252 R253 R332 R333 R352 R353 | 13 | 3.3-Ω, 100-mW, 5% 0603 metal film resistor | BC Components | DCT 0603 5% 3R30 |
| R51 R52 | 2 | 1.0-kΩ, 100-mW, 5% 0603 metal film resistor | BC Components | DCT 0603 5% 1k00 |
| R53 | 1 | 100-kΩ, 100-mW, 5% 0603 metal film resistor | BC Components | DCT 0603 5% 100k |
| R54 R55 R56 R57 R58 R60 R61 R62 R63 R64 R65 R66 R74 R75 | 14 | 47-Ω, 100-mW, 5% 0603 metal film resistor | BC Components | DCT 0603 5% 47R0 |
| R105 R205 R305 | 3 | 22-kΩ, 100-mW, 5% 0603 metal film resistor | BC Components | DCT 0603 5% 22k0 |
| R900 R940 R951 R952 R953 | 5 | 3.30-Ω, 125-mW, 1% 0805 metal film resistor | BC Components | DCU 0805 1% 3R30 |
| R901 | 1 | 10.0-kΩ, 250-mW, 1% 1206 metal film resistor | BC Components | DCA 1206 1% 10k0 |
| SCREW630 SCREW631 SCREW632 SCREW633 SCREW634 SCREW635 SCREW636 SCREW637 | 8 | M3x6, pan head, Pozidriv™, A2 screw | Bossard | BN 81882 M3x6 |
| STANDOFF634 STANDOFF635 STANDOFF636 STANDOFF637 | 4 | M3x10 aluminium standoff | Ettinger | 05.03.108 |
| U10 | 1 | 6-ch PWM processor (SE, VOL, 192-kHz, I ² S out) (TSSOP38) | Texas Instruments | TAS5086DBT |
| U100 U200 U300 | 3 | 4-ch/2-ch/1-ch digital audio PWM power output stage (DDV44) | Texas Instruments | TAS5142DDV |
| U908 | 1 | 3.3-V supply voltage supervisor (SOT23-5) | Texas Instruments | TPS3825-33DBVT |
| U900 | 1 | 12-V, 500-mA positive voltage regulator (KTP) | Texas Instruments | UA78M12CKTPR |
| U901 | 1 | 5-V, 0.5-A buck converter (SO8) | National Semiconductor | LM2594M-5.0V |
| U907 | 1 | 3.3-V, 150-mA low-drop linear regulator (SOT23-5) | Texas Instruments | TPS76433DBVR |
| WASHER630 WASHER631 WASHER632 WASHER633 WASHER634 WASHER635 WASHER636 WASHER637 | 8 | M3 stainless steel spring washer | Bossard | BN 760 M3 |

A.3 TAS5142DDV6EVM2 PCB Specification (Version 4.00)

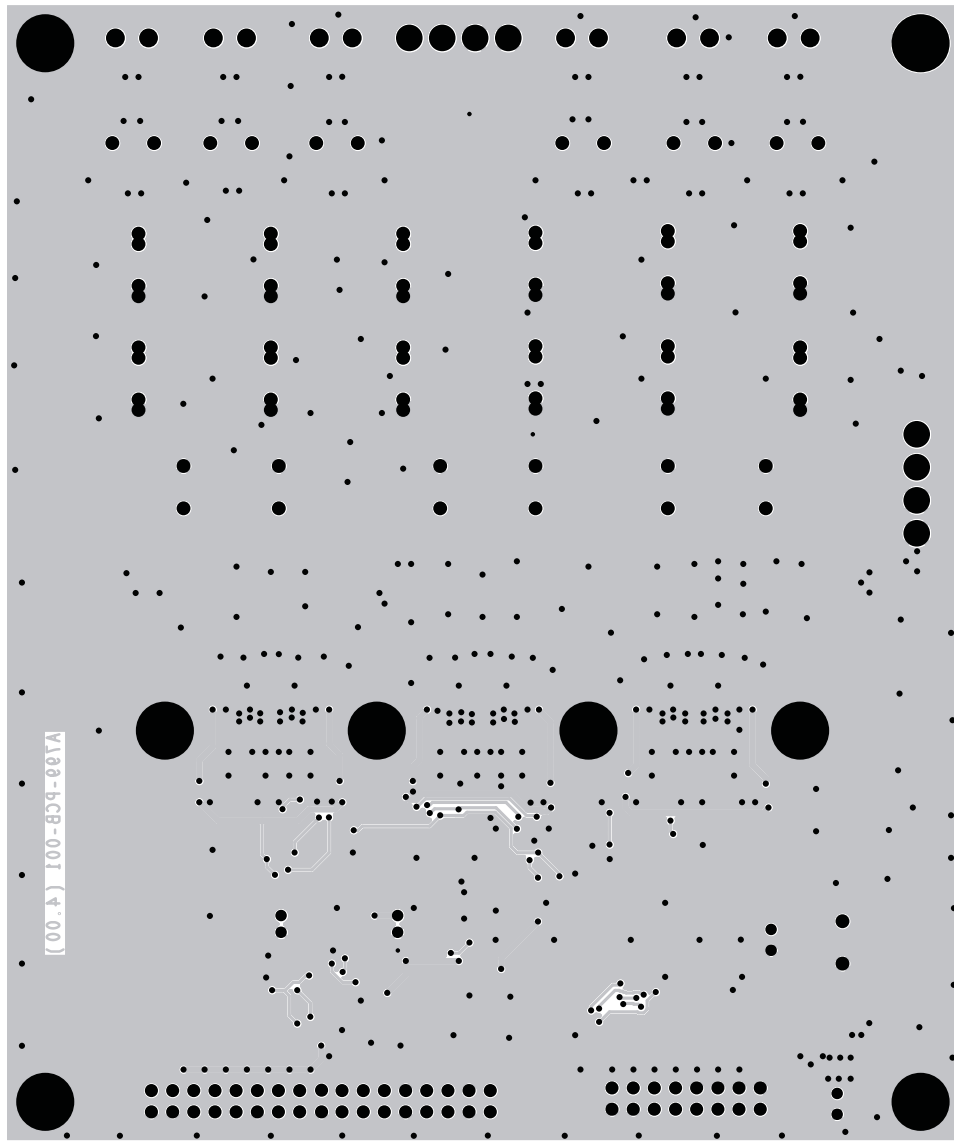
| | |
|------------------------------|---|
| Board identification: | A799-PCB-001(4.00) |
| Board type: | Double-sided plated-through board |
| Laminate type: | FR4 |
| Laminate thickness: | 1,6 mm |
| Copper thickness: | 70 µm (incl. plating exterior layer) |
| Copper plating of holes: | >25 µm |
| Minimum hole diameter : | 0,3 mm |
| Silkscreen, component side: | White - remove silkscreen from solder area and pre-tinned areas |
| Silkscreen, solder side: | None |
| Solder mask, component side: | Green |
| Solder mask solder side: | Green |
| Protective coating: | Solder coating and chemical silver on free copper |
| Electrical test: | PCB must be electrically tested |
| Manufactured to: | PERFAG 2E (www.perfag.dk) |
| Aperture table: | PERFAG 10A (www.perfag.dk) |
| Board size: | 115 mm x 137 mm |
| Comments: | See drill information file (5140dri.plt.pdf). |

A.4 TAS5142DDV6EVM2 PCB Layers



K001

Figure A-8. Component Layout



K002

Figure A-9. Solder Side

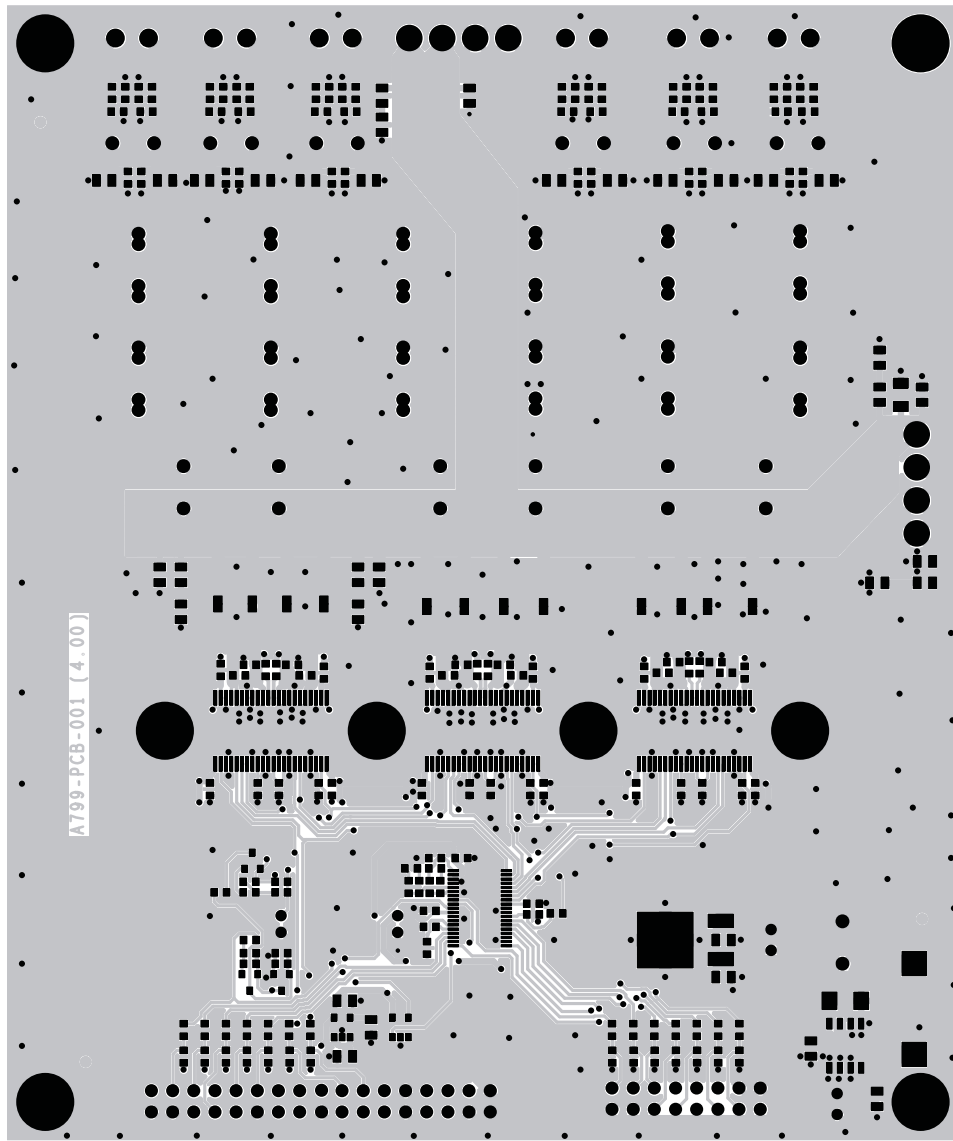
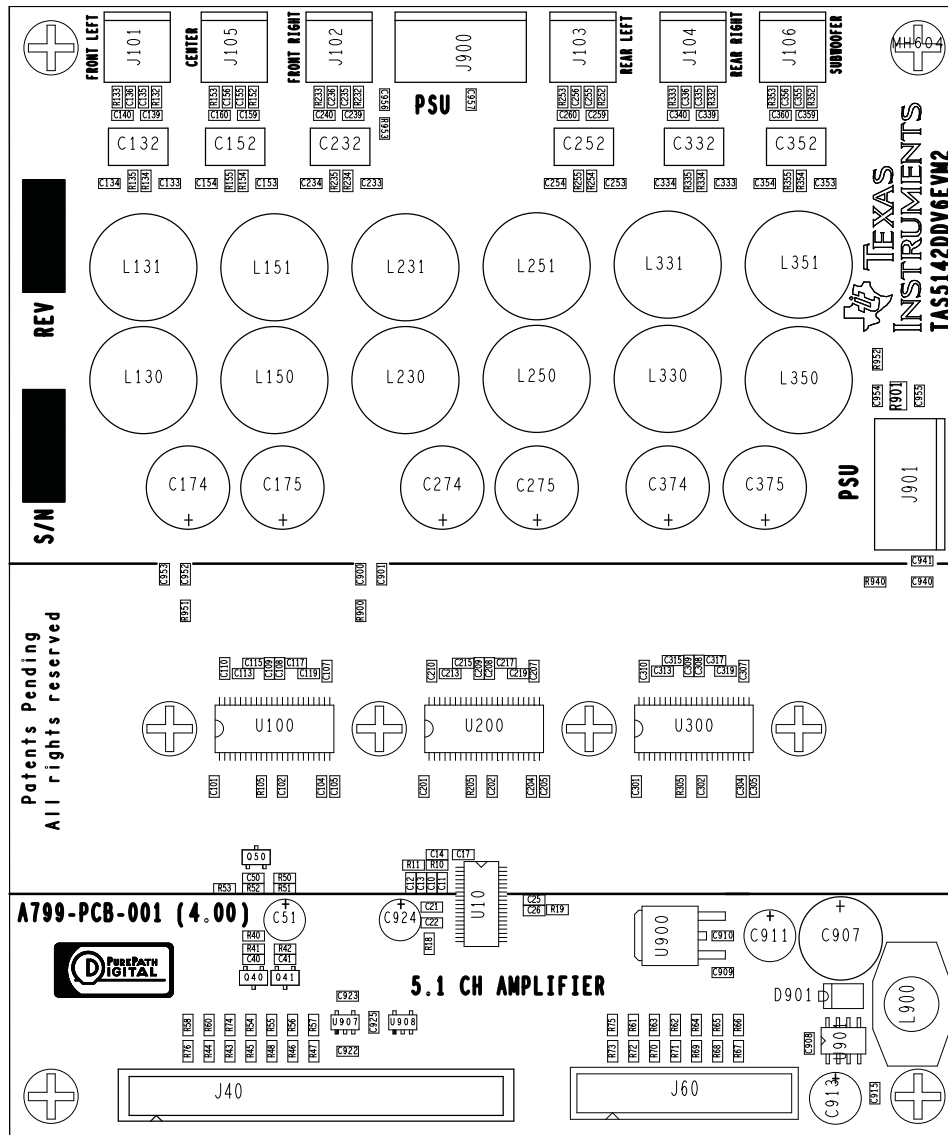
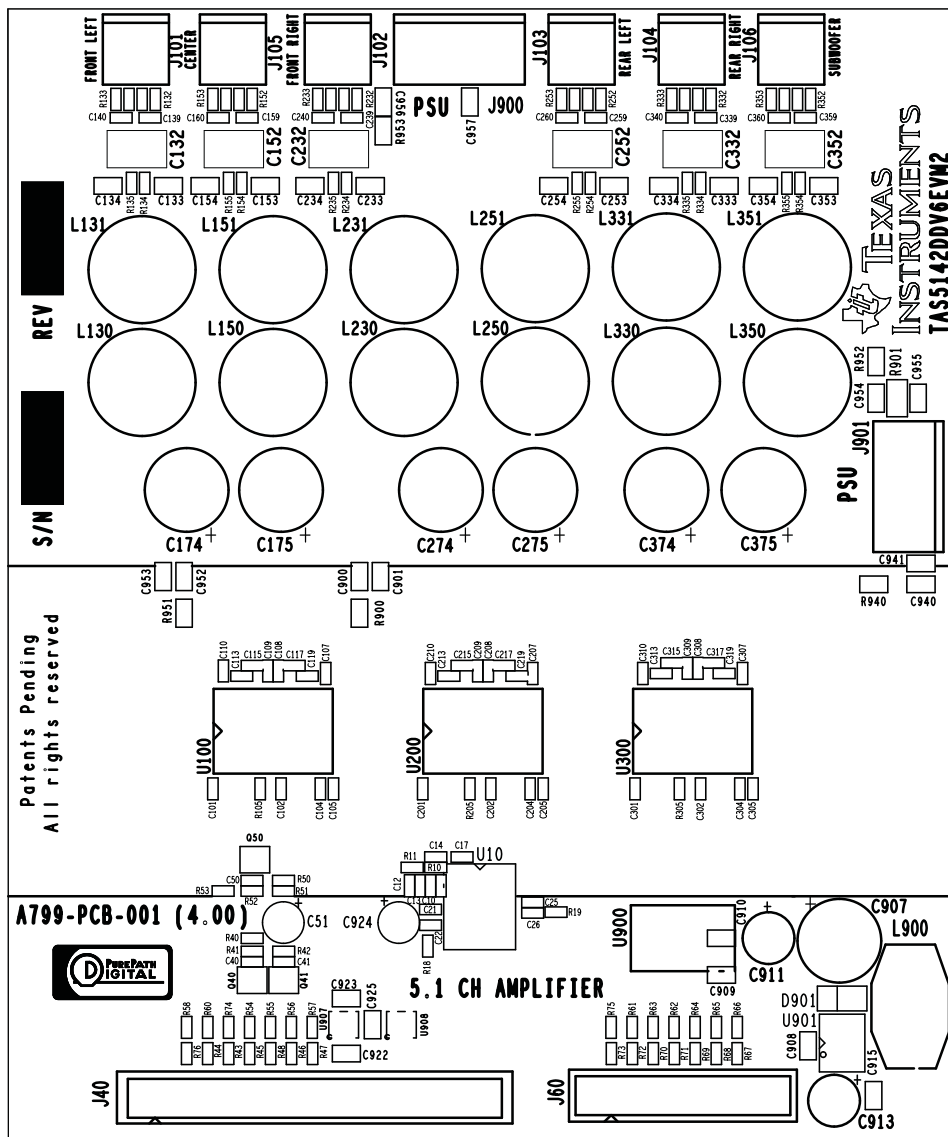


Figure A-10. Component Side



K004

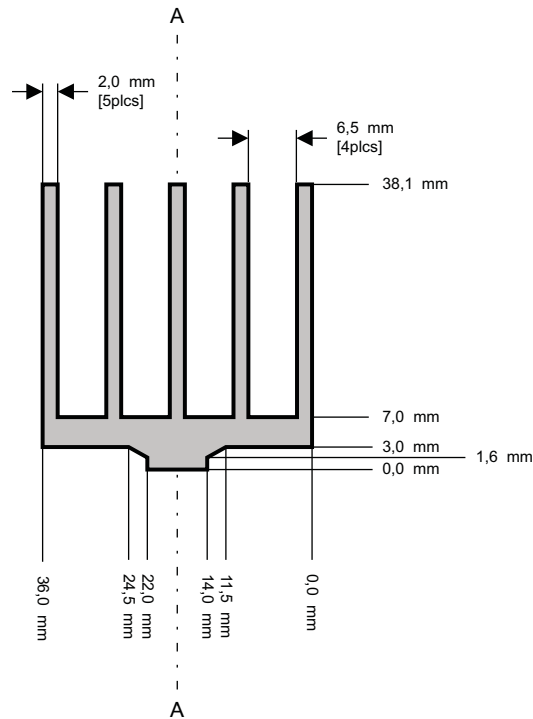
Figure A-11. Component Placement



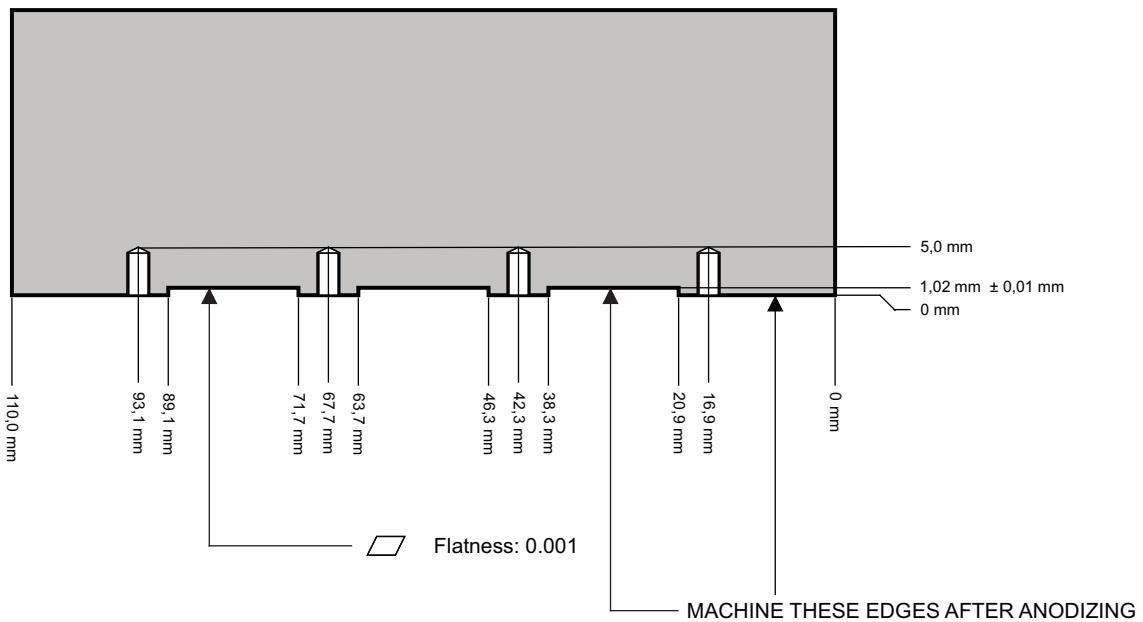
K005

Figure A-12. Silkscreen

A.5 Heat Sink Drawing



Cross section A-A



PROFILE: TIC-HSINK-043 profile (1.00)

MATERIAL: ALUMINIUM

INTERNAL SCREW THREADS: M3

SURFACE: FREE OF SHARP EDGES

SURFACE TREATMENT: BLACK ANODIZED

TOLERANCES: $\pm 0,1$ mm

M0079-01

Figure A-13. Heat Sink

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Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 50°C. The EVM is designed to operate properly with certain components above 50°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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